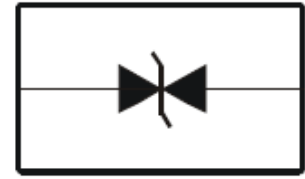


Features

- ESD / transient protection of high speed data lines
 - IEC 61000-4-2 (ESD): $\pm 25\text{kV}$ (air), $\pm 25\text{kV}$ (contact)
- Suitable replacement for MLV'S ESD protection
- Low leakage current
- Low clamping voltage
- RoHS compliant with Halogen-free

HF

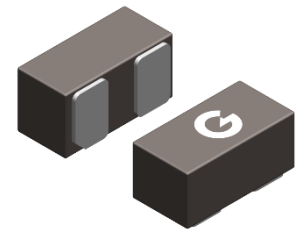


Typical Applications

- Cellular handsets
- Portable electronics
- Communication systems
- Audio and video equipment

Mechanical Data

- Case: DFN0603-2L
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



DFN0603-2L

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
GESD5V5B2LP3	DFN0603-2L	10000 pcs / Tape & Reel	5B

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
IEC 61000-4-2; ESD (Air)	$V_{\text{ESD-A}}$	± 25	kV
IEC 61000-4-2; ESD (Contact)	$V_{\text{ESD-C}}$	± 25	kV
Reverse Stand-off Voltage	V_{RWM}	± 5.5	V
Peak Pulse Power ($t_p = 8/20\mu\text{s}$)	P_{PP}	70	W
Peak Pulse Current ($t_p = 8/20\mu\text{s}$)	I_{PP}	± 7	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	0.25	W
Thermal Resistance Junction-to-Air	$R_{\theta JA}$	400	$^{\circ}C/W$
Thermal Resistance Junction-to-Lead	$R_{\theta JL}$	204	$^{\circ}C/W$
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	240	$^{\circ}C/W$
Operating Temperature	T_J	-55 ~ +125	$^{\circ}C$
Storage Temperature	T_{STG}	-55 ~ +150	$^{\circ}C$

Electrical Characteristics (@ $T_A = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Reverse Breakdown Voltage	V_{BR}	$I_R = 1mA$	6.0	-	10	V
Reverse Leakage Current	I_R	$V_{RWM} = 5.5V$	-	-	100	nA
Clamping Voltage	V_C	$I_{PP} = 1A, (t_p = 8/20\mu s)$	-	-	8.5	V
		$I_{PP} = 7A, (t_p = 8/20\mu s)$	-	-	12.0	V
Diode Capacitance	C_J	$V_R = 0V, f = 1MHz$	-	15	18	pF

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

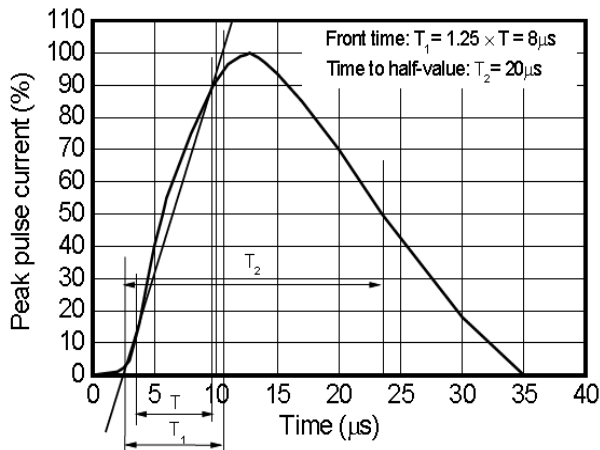


Fig 1 8/20 μs waveform per IEC61000-4-5

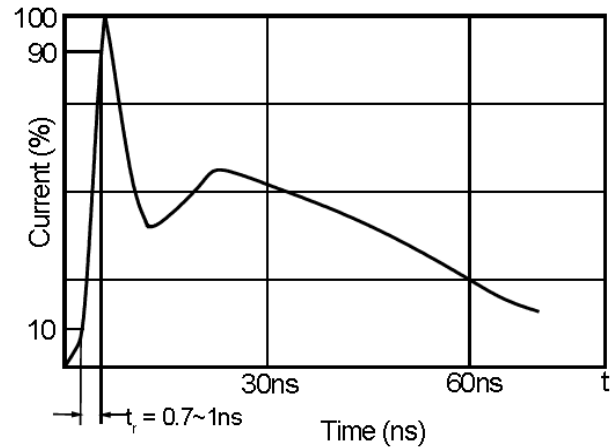


Fig 2 ESD pulse waveform according to IEC61000-4-2

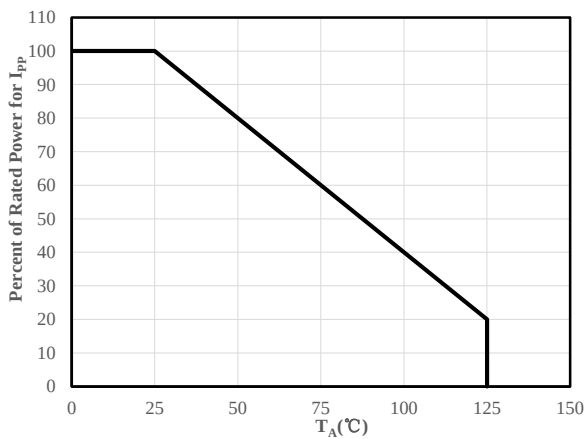


Fig 3 Power Derating Curve

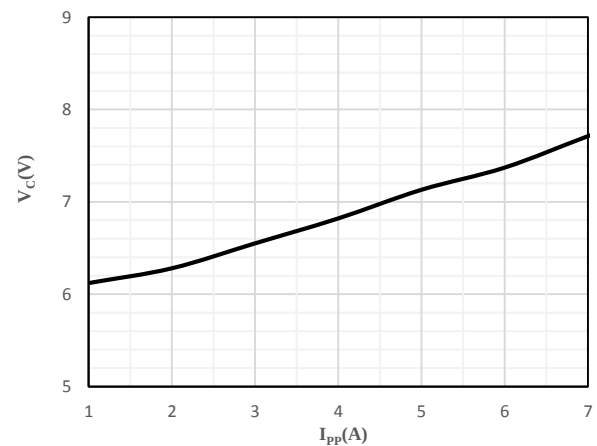


Fig 4 Clamping Voltage vs. Peak Pulse Current

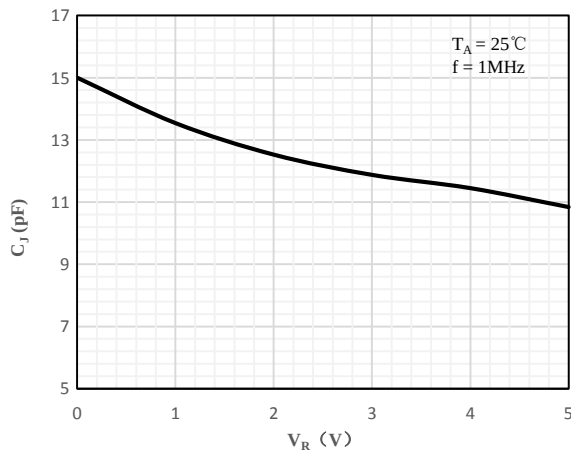


Fig 5 Capacitance vs. Reverse Voltage

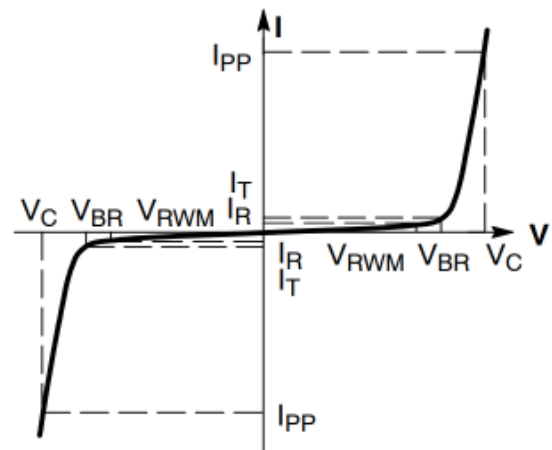
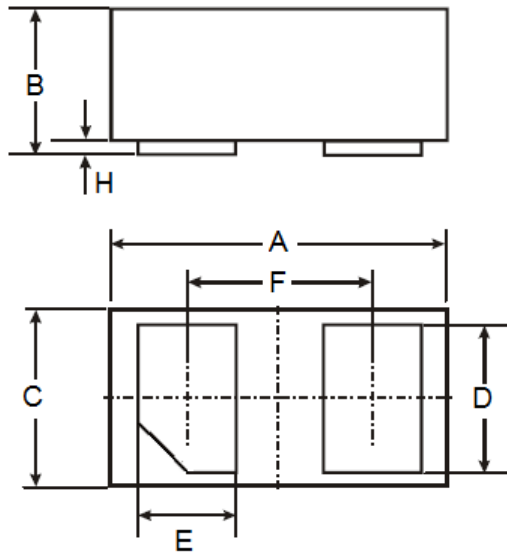


Fig 6 IV curve

Package Outline Dimensions (Unit: mm)



DFN0603-2L			
Dimension	Min.	Typ.	Max.
A	0.595	0.620	0.645
B	0.270	0.300	0.350
C	0.295	0.320	0.345
D	0.190	0.240	0.290
E	0.140	0.190	0.240
F	-	0.355	-
H	0	0.020	0.030

Mounting Pad Layout (Unit: mm)

DFN0603-2L

